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S10CG, S10CJ, S10CK, S10CM

Vishay General Semiconductor

Surface-Mount Glass Passivated Rectifier



SMC (DO-214AB)

Cathode O Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	10 A				
V _{RRM}	400 V, 600 V, 800 V, 1000 V				
I _{FSM}	300 A				
I _R	10 µA				
V_F at I_F = 10 A (T_A = 125 °C)	0.87 V				
T _J max.	150 °C				
Package	SMC (DO-214AB)				
Circuit configurations	Single				

FEATURES

- Low profile package
- · Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- · Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMC (DO-214AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test **Polarity:** color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	S10CG	S10CJ	S10CK	S10CM	UNIT
Device marking code		10G	10J	10K	10M	
Maximum repetitive peak reverse voltage	V _{RRM}	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	400	600	800	1000	V
Maximum average forward restified autrent	I _{F(AV)} ⁽¹⁾		А			
Maximum average forward rectified current	I _{F(AV)} ⁽²⁾		А			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	300				А
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150				°C

Notes

⁽¹⁾ Mounted on aluminum PCB 30 mm x 30 mm with aluminum heatsink

⁽²⁾ Free air, mounted on recommended copper pad area

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RoHS

COMPLIANT

HALOGEN



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ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_{F} = 5.0 \text{ A}$	— T _A = 25 °C	- V _F (1)	0.9	-	V	
	I _F = 10.0 A			0.96	1.0		
	I _F = 5.0 A	– T _A = 125 °C		0.8	-		
	I _F = 10.0 A			0.87	0.95		
Reverse current	Rated V _B	T _A = 25 °C	– I _R ⁽²⁾	-	10		
	naleu v _R	T _A = 125 °C		-	350	μA	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	5	-	μs	
Typical junction capacitance	4.0 V, 1 MHz		CJ	79	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width; 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	S10CG	S10CJ	S10CK	S10CM	UNIT
Typical thermal resistance	R _{0JA} ⁽¹⁾	75				°C/W
	R _{θJM} ⁽²⁾	9.3				0/10

Notes

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz.pad area; thermal resistance $R_{\theta,JA}$ - junction to ambient

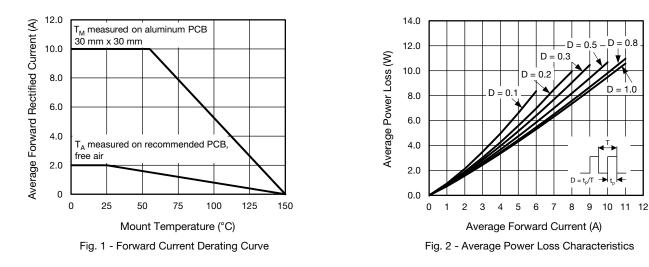
⁽²⁾ Mounted on 30 mm x 30 mm Aluminum PCB, thermal resistance R_{0JM} - junction to mount

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
S10CJ-M3/I	0.257	I	3500	13" diameter plastic tape and reel			
S10CJHM3/I ⁽¹⁾	0.257	l	3500	13" diameter plastic tape and reel			

Note

⁽¹⁾ AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)



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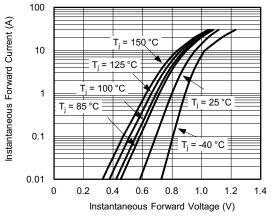


Fig. 3 - Typical Instantaneous Forward Characteristics

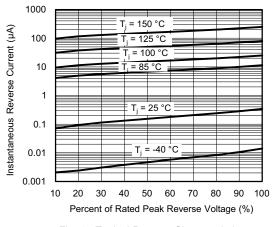
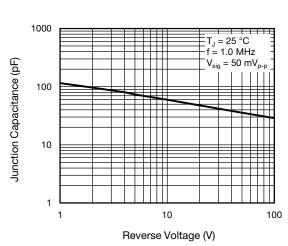


Fig. 4 - Typical Reverse Characteristics





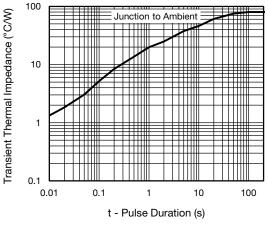
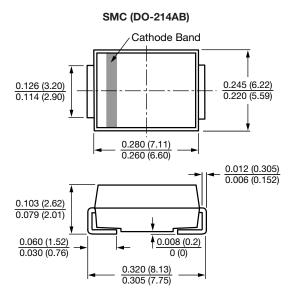
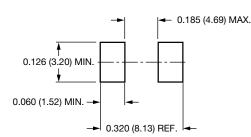


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Mounting Pad Layout



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